



IGBT, Brems-Chopper / IGBT, Brake-Chopper
Höchstzulässige Werte / Maximum Rated Values

Vorläufige Daten
Preliminary Data

Kollektor-Emitter-Sperrspannung Collector-emitter voltage	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = -25^{\circ}\text{C}$	V_{CES}	3300 3300	V
Kollektor-Dauergleichstrom Continuous DC collector current	$T_C = 80^{\circ}\text{C}, T_{vj\text{max}} = 150^{\circ}\text{C}$ $T_C = 25^{\circ}\text{C}, T_{vj\text{max}} = 150^{\circ}\text{C}$	$I_{C\text{nom}}$ I_C	800 1300	A A
Periodischer Kollektor-Spitzenstrom Repetitive peak collector current	$t_P = 1\text{ ms}$	I_{CRM}	1600	A
Gesamt-Verlustleistung Total power dissipation	$T_C = 25^{\circ}\text{C}, T_{vj\text{max}} = 150^{\circ}\text{C}$	P_{tot}	9,60	kW
Gate-Emitter-Spitzenspannung Gate-emitter peak voltage		V_{GES}	+/-20	V

Charakteristische Werte / Characteristic Values

			min.	typ.	max.		
Kollektor-Emitter-Sättigungsspannung Collector-emitter saturation voltage	$I_C = 800\text{ A}, V_{GE} = 15\text{ V}$ $I_C = 800\text{ A}, V_{GE} = 15\text{ V}$	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$	$V_{CE\text{sat}}$	3,40 4,30	4,25 5,00	V V	
Gate-Schwellenspannung Gate threshold voltage	$I_C = 80,0\text{ mA}, V_{CE} = V_{GE}, T_{vj} = 25^{\circ}\text{C}$		$V_{G\text{eth}}$	4,2	5,1	6,0	V
Gateladung Gate charge	$V_{GE} = -15\text{ V} \dots +15\text{ V}, V_{CE} = 1800\text{ V}$		Q_G	15,0			μC
Interner Gatewiderstand Internal gate resistor	$T_{vj} = 25^{\circ}\text{C}$		$R_{G\text{int}}$	0,63			Ω
Eingangskapazität Input capacitance	$f = 1\text{ MHz}, T_{vj} = 25^{\circ}\text{C}, V_{CE} = 25\text{ V}, V_{GE} = 0\text{ V}$		C_{ies}	100			nF
Rückwirkungskapazität Reverse transfer capacitance	$f = 1\text{ MHz}, T_{vj} = 25^{\circ}\text{C}, V_{CE} = 25\text{ V}, V_{GE} = 0\text{ V}$		C_{res}	5,40			nF
Kollektor-Emitter-Reststrom Collector-emitter cut-off current	$V_{CE} = 3300\text{ V}, V_{GE} = 0\text{ V}, T_{vj} = 25^{\circ}\text{C}$		I_{CES}		5,0		mA
Gate-Emitter-Reststrom Gate-emitter leakage current	$V_{CE} = 0\text{ V}, V_{GE} = 20\text{ V}, T_{vj} = 25^{\circ}\text{C}$		I_{GES}		400		nA
Einschaltverzögerungszeit, induktive Last Turn-on delay time, inductive load	$I_C = 800\text{ A}, V_{CE} = 1800\text{ V}$ $V_{GE} = \pm 15\text{ V}$ $R_{G\text{on}} = 1,4\ \Omega, C_{GE} = 150\text{ nF}$	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$	$t_{d\text{on}}$	0,28 0,28			μs μs
Anstiegszeit, induktive Last Rise time, inductive load	$I_C = 800\text{ A}, V_{CE} = 1800\text{ V}$ $V_{GE} = \pm 15\text{ V}$ $R_{G\text{on}} = 1,4\ \Omega, C_{GE} = 150\text{ nF}$	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$	t_r	0,18 0,20			μs μs
Abschaltverzögerungszeit, induktive Last Turn-off delay time, inductive load	$I_C = 800\text{ A}, V_{CE} = 1800\text{ V}$ $V_{GE} = \pm 15\text{ V}$ $R_{G\text{off}} = 1,8\ \Omega, C_{GE} = 150\text{ nF}$	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$	$t_{d\text{off}}$	1,55 1,70			μs μs
Fallzeit, induktive Last Fall time, inductive load	$I_C = 800\text{ A}, V_{CE} = 1800\text{ V}$ $V_{GE} = \pm 15\text{ V}$ $R_{G\text{off}} = 1,8\ \Omega, C_{GE} = 150\text{ nF}$	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$	t_f	0,20 0,20			μs μs
Einschaltverlustenergie pro Puls Turn-on energy loss per pulse	$I_C = 800\text{ A}, V_{CE} = 1800\text{ V}, L_S = 40\text{ nH}$ $V_{GE} = \pm 15\text{ V}$ $R_{G\text{on}} = 1,4\ \Omega, C_{GE} = 150\text{ nF}$	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$	E_{on}	930 1450			mJ mJ
Abschaltverlustenergie pro Puls Turn-off energy loss per pulse	$I_C = 800\text{ A}, V_{CE} = 1800\text{ V}, L_S = 40\text{ nH}$ $V_{GE} = \pm 15\text{ V}$ $R_{G\text{off}} = 1,8\ \Omega, C_{GE} = 150\text{ nF}$	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$	E_{off}	870 1000			mJ mJ
Kurzschlußverhalten SC data	$V_{GE} \leq 15\text{ V}, V_{CC} = 2500\text{ V}$ $V_{CE\text{max}} = V_{CES} - L_{S\text{CE}} \cdot di/dt$	$t_P \leq 10\ \mu\text{s}, T_{vj} = 125^{\circ}\text{C}$	I_{SC}	4000			A
Wärmewiderstand, Chip bis Gehäuse Thermal resistance, junction to case	pro IGBT / per IGBT		$R_{th\text{JC}}$		13,0		K/kW
Wärmewiderstand, Gehäuse bis Kühlkörper Thermal resistance, case to heatsink	pro IGBT / per IGBT $\lambda_{\text{Paste}} = 1\text{ W}/(\text{m}\cdot\text{K}) / \lambda_{\text{grease}} = 1\text{ W}/(\text{m}\cdot\text{K})$		$R_{th\text{CH}}$	8,00			K/kW
Temperatur im Schaltbetrieb Temperature under switching conditions			$T_{vj\text{op}}$	-40	125		$^{\circ}\text{C}$

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**Vorläufige Daten
Preliminary Data**

**Diode, Brems-Chopper / Diode, Brake-Chopper
Höchstzulässige Werte / Maximum Rated Values**

Periodische Spitzensperrspannung Repetitive peak reverse voltage	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = -25^{\circ}\text{C}$	V_{RRM}	3300 3300	V
Dauergleichstrom Continuous DC forward current		I_F	800	A
Periodischer Spitzenstrom Repetitive peak forward current	$t_P = 1 \text{ ms}$	I_{FRM}	1600	A
Grenzlastintegral I^2t - value	$V_R = 0 \text{ V}$, $t_P = 10 \text{ ms}$, $T_{vj} = 125^{\circ}\text{C}$	I^2t	220	kA^2s
Spitzenverlustleistung Maximum power dissipation	$T_{vj} = 125^{\circ}\text{C}$	P_{RQM}	1600	kW
Mindesteinschaltdauer Minimum turn-on time		$t_{on \text{ min}}$	10,0	μs

Charakteristische Werte / Characteristic Values

			min.	typ.	max.	
Durchlassspannung Forward voltage	$I_F = 800 \text{ A}$, $V_{GE} = 0 \text{ V}$	$T_{vj} = 25^{\circ}\text{C}$	V_F	2,80	3,50	V
	$I_F = 800 \text{ A}$, $V_{GE} = 0 \text{ V}$	$T_{vj} = 125^{\circ}\text{C}$				
Rückstromspitze Peak reverse recovery current	$I_F = 800 \text{ A}$, $-di_F/dt = 4500 \text{ A}/\mu\text{s}$ ($T_{vj}=125^{\circ}\text{C}$) $V_R = 1800 \text{ V}$ $V_{GE} = -15 \text{ V}$	$T_{vj} = 25^{\circ}\text{C}$	I_{RM}	1100	1300	A A
		$T_{vj} = 125^{\circ}\text{C}$				
Sperrverzögerungsladung Recovered charge	$I_F = 800 \text{ A}$, $-di_F/dt = 4500 \text{ A}/\mu\text{s}$ ($T_{vj}=125^{\circ}\text{C}$) $V_R = 1800 \text{ V}$ $V_{GE} = -15 \text{ V}$	$T_{vj} = 25^{\circ}\text{C}$	Q_r	500	900	μC μC
		$T_{vj} = 125^{\circ}\text{C}$				
Abschaltenergie pro Puls Reverse recovery energy	$I_F = 800 \text{ A}$, $-di_F/dt = 4500 \text{ A}/\mu\text{s}$ ($T_{vj}=125^{\circ}\text{C}$) $V_R = 1800 \text{ V}$ $V_{GE} = -15 \text{ V}$	$T_{vj} = 25^{\circ}\text{C}$	E_{rec}	490	1150	mJ mJ
		$T_{vj} = 125^{\circ}\text{C}$				
Wärmewiderstand, Chip bis Gehäuse Thermal resistance, junction to case	pro Diode / per diode		R_{thJC}		26,0	K/kW
Wärmewiderstand, Gehäuse bis Kühlkörper Thermal resistance, case to heatsink	pro Diode / per diode $\lambda_{\text{Paste}} = 1 \text{ W}/(\text{m}\cdot\text{K})$ / $\lambda_{\text{grease}} = 1 \text{ W}/(\text{m}\cdot\text{K})$		R_{thCH}	16,0		K/kW
Temperatur im Schaltbetrieb Temperature under switching conditions			$T_{vj \text{ op}}$	-40	125	$^{\circ}\text{C}$

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